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**華凌光電股份有限公司**



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## SPECIFICATION

**CUSTOMER :** \_\_\_\_\_

**MODULE NO.:**                     **WX12864U-TFH#**                    

<b>APPROVED BY:</b>		
( FOR CUSTOMER USE ONLY )	<b>PCB VERSION:</b>	<b>DATA:</b>

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.	SUMMARY
A	2008.09.15	11	Modify contour drawing.



**RECORDS OF REVISION**

**DOC. FIRST ISSUE**

VERSION	DATE	REVISED PAGE NO.	<b>SUMMARY</b>
0	2008/8/22		First issue
A	2008.09.15	11	Modify contour drawing.

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# 1. Module Classification Information

W X   1 2 8 6 4 U — T F H #  
 ① ②                    ③                    ④                    ⑤ ⑥ ⑦                    ⑧

- ① Brand : WINSTAR DISPLAY CORPORATION
- ② Display Type : H→Character Type, G→Graphic Type, X→Tab Type
- ③ Display Font : Graphic 128\*64 Dots
- ④ Model serials no.
- ⑤ Backlight Type :      N→Without backlight                    T→LED, White  
                                   B→EL, Blue green                                    A→LED, Amber  
                                   D→EL, Green    R→LED, Red  
                                   W→EL, White    O→LED, Orange  
                                   F→CCFL, White                                        G→LED, Green  
                                   Y→LED, Yellow Green
- ⑥ LCD Mode :            B→TN Positive, Gray                    T→FSTN Negative  
                                   N→TN Negative,  
                                   G→STN Positive, Gray  
                                   Y→STN Positive, Yellow Green  
                                   M→STN Negative, Blue  
                                   F→FSTN Positive
- ⑦ LCD Polarizer Type/    A→Reflective, N.T, 6:00                    H→Transflective, W.T,6:00  
   Temperature range/    D→Reflective, N.T, 12:00                    K→Transflective, W.T,12:00  
   View direction            G→Reflective, W. T, 6:00                    C→Transmissive, N.T,6:00  
                                   J→Reflective, W. T, 12:00                    F→Transmissive, N.T,12:00  
                                   B→Transflective, N.T,6:00                    I→Transmissive, W. T, 6:00  
                                   E→Transflective, N.T.12:00                    L→Transmissive, W.T,12:00
- ⑧ Special Code            #: Fit in with the ROHS directives and regulations

## 2. Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3) Don't disassemble the LCM.
- (4) Don't operate it above the absolute maximum rating.
- (5) Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.

## 3. General Specification

<b>Item</b>	<b>Dimension</b>	<b>Unit</b>
Number of Characters	128 x 64	—
Module dimension	58.2 x63.1 x5.5(MAX)	mm
View area	52.0x 33.5	mm
Active area	47.76x 30.29	mm
Dot size	0.4x0.35	mm
Dot pitch	0.42x 0.37	mm
LCD type	FSTN Positive Transflective (In LCD production, It will occur slightly color difference. We can only guarantee the same color in the same batch.)	
Duty	1/64	
View direction	6 o'clock	
Backlight Type	LED, White	

## 4. Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	$T_{OP}$	-20	—	+70	°C
Storage Temperature	$T_{ST}$	-30	—	+80	°C
Input Voltage	$V_I$	$V_{SS}$	—	$V_{DD}$	V
Supply Voltage For Logic	$V_{DD}-V_{SS}$	1.8	—	3.6	V
Supply Voltage For LCD	$V_{OUT}-V_{SS}$	6.0	—	14.2	V

## 5. Electrical Characteristics

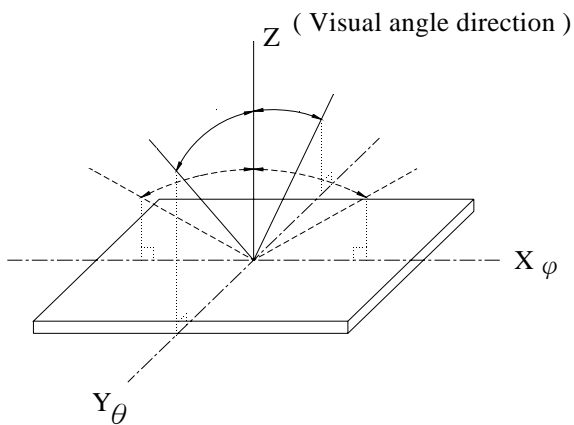
Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage For Logic	$V_{DD}-V_{SS}$	—	—	3.3	—	V
Supply Voltage For LCD	$V_{DD}-V_{OUT}$	$T_a=-20^{\circ}\text{C}$	—	—	—	V
		$T_a=25^{\circ}\text{C}$	—	8.5	—	V
		$T_a=70^{\circ}\text{C}$	—	—	—	V
Input High Volt.	$V_{IH}$	—	$0.8 V_{DD}$	—	$V_{DD}$	V
Input Low Volt.	$V_{IL}$	—	$V_{SS}$	—	$0.2 V_{DD}$	V
Output High Volt.	$V_{OH}$	—	$0.8 V_{DD}$	—	$V_{DD}$	V
Output Low Volt.	$V_{OL}$	—	$V_{SS}$	—	$0.2 V_{DD}$	V
Supply Current	$I_{DD}$	$V_{DD}=3.3\text{V}$	0.18	0.18	0.18	mA

# 6. Optical Characteristics

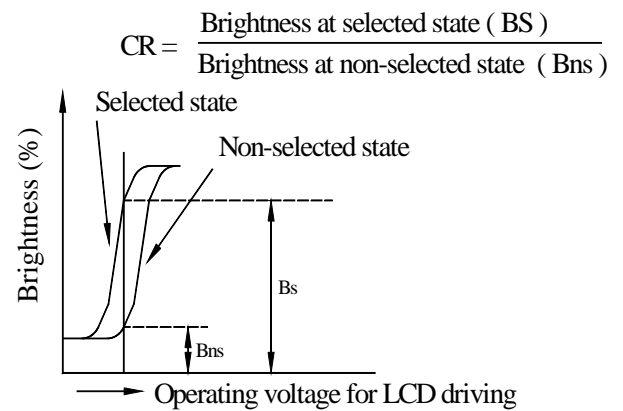
Item	Symbol	Condition	Min	Typ	Max	Unit
View Angle	(V) $\theta$	$CR \geq 2$	30	—	60	deg
	(H) $\varphi$	$CR \geq 2$	-45	—	45	deg
Contrast Ratio	CR	—	—	5	—	—
Response Time	T rise	—	—	110	220	ms
	T fall	—	—	260	520	ms

## 6.1 Definitions

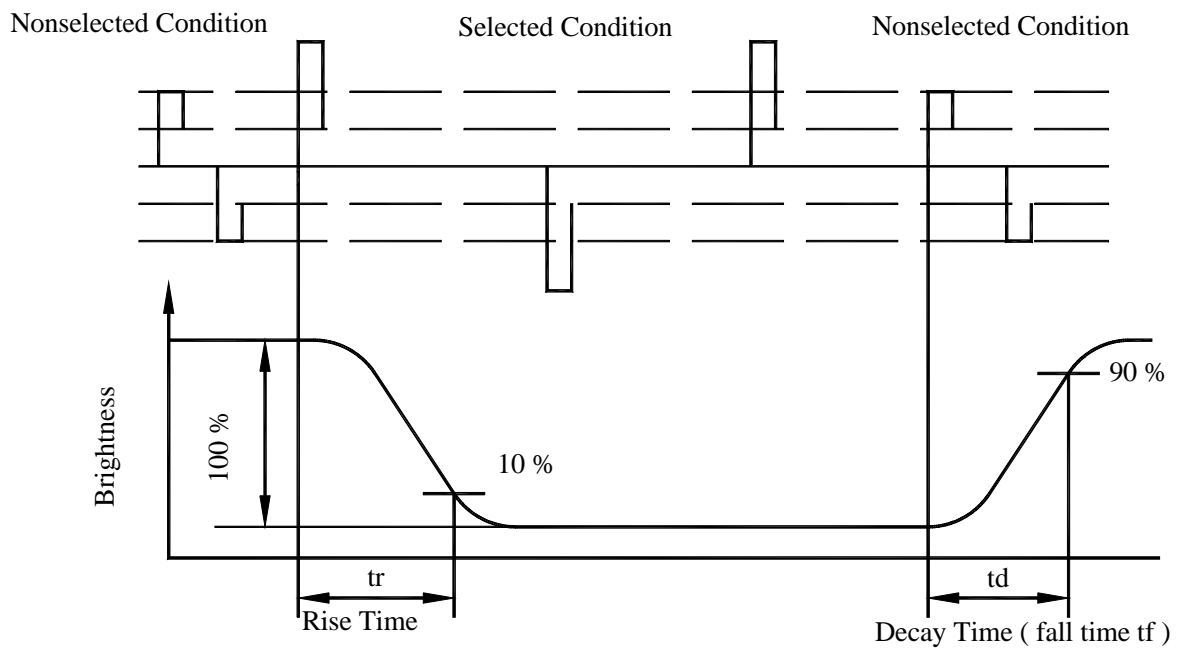
### ■ View Angles



### ■ Contrast Ratio



### ■ Response Time



# 7. Interface Description

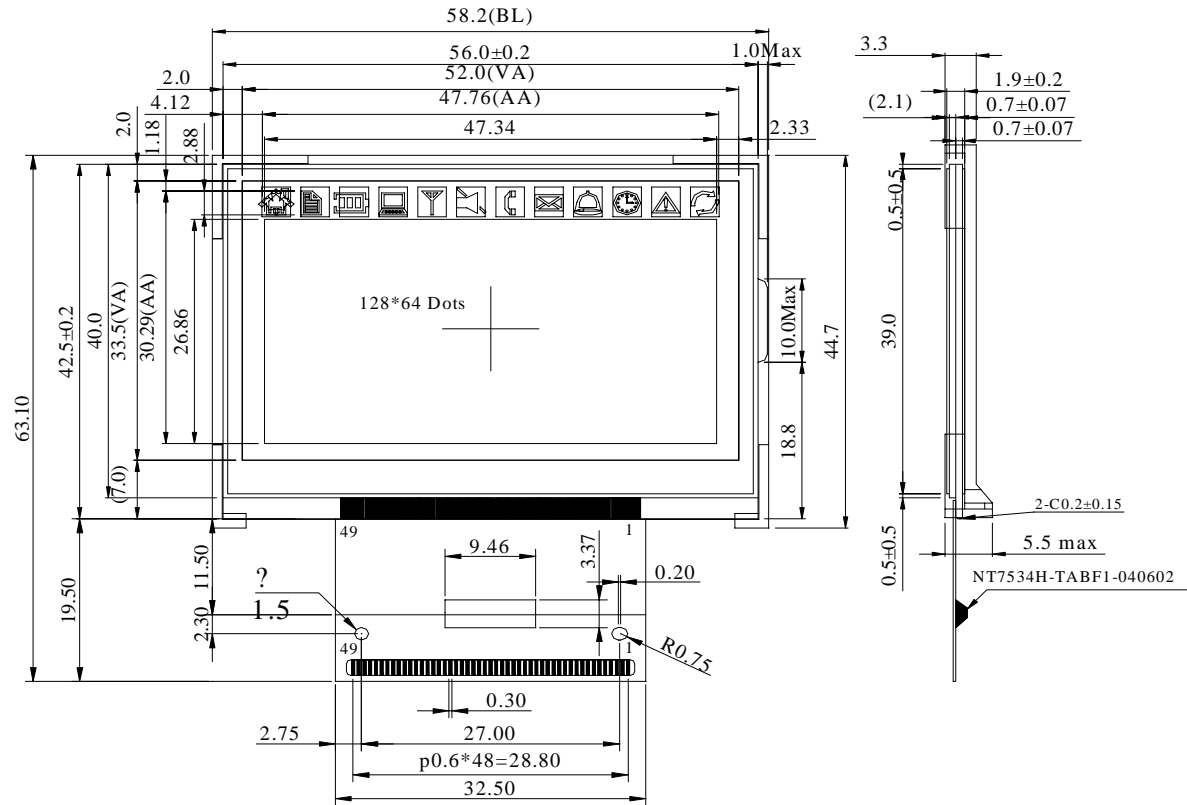
Pin No.	Symbol	I/O	Description															
1	NC		No connection															
2	IRS	I	This terminal selects the resistors for the V0 voltage level adjustment IRS = "H", Use the internal resistors IRS = "L", Do not use the internal resistors The V0 voltage level is regulated by an external resistive voltage divider attached to the VR terminal. This pad is enabled only when the master operation mode is selected. It is fixed to either "H" or "L" when the slave operation mode is selected															
3	/HPM	I	This is the power control terminal for the power supply circuit for liquid crystal drive. /HPM = "H", Normal power mode /HPM = "L", High power mode This pad is enabled only when the master operation mode is selected and it is fixed to either "H" or "L" when the slave operation mode is selected.															
4	P/S	I	This is the parallel data input/serial data input switch terminal P/S = "H": Parallel data input P/S = "L": Serial data input The following applies depending on the P/S status: <table border="1" data-bbox="593 1104 1509 1283"> <thead> <tr> <th>P/S</th> <th>Data/Command</th> <th>Data</th> <th>Read/Write</th> <th>Serial Clock</th> </tr> </thead> <tbody> <tr> <td>"H"</td> <td>A0</td> <td>D0 to D7</td> <td>/RD, /WR</td> <td>-</td> </tr> <tr> <td>"L"</td> <td>A0</td> <td>SI (D7)</td> <td>Write only</td> <td>SCL (D6)</td> </tr> </tbody> </table> When P/S = "L", fix D0~D5 pads to VDD or VSS level. /RD(E) and /WR (R/W) are fixed to either "H" or "L". With serial data input, RAM display data reading is not supported.	P/S	Data/Command	Data	Read/Write	Serial Clock	"H"	A0	D0 to D7	/RD, /WR	-	"L"	A0	SI (D7)	Write only	SCL (D6)
P/S	Data/Command	Data	Read/Write	Serial Clock														
"H"	A0	D0 to D7	/RD, /WR	-														
"L"	A0	SI (D7)	Write only	SCL (D6)														
5	C86	I	This is the MPU interface switch terminal C86 = "H": 6800 Series MPU interface C86 = "L": 8080 Series MPU interface															
6	CLS	I	Terminal to select whether enable or disable the display clock internal oscillator circuit. CLS = "H": Internal oscillator circuit for display is enabled CLS = "L": Internal oscillator circuit for display is enabled (requires external input) When CLS = "L", input the display clock through the CL pad.															
7	M/S	I	This terminal selects the master/slave operation for the NT7534 chips. Master operation outputs the timing signals that required for LCD display, while slave operation inputs the timing signals required for the liquid crystal display, synchronizing the liquid crystal display system.															
8	VR	I	Voltage adjustment pad. Applies voltage between V0 and VSS using a resistive divider.															
9	V0	I/O	LCD driver supplies voltages. The voltage determined by the LCD cell is impedance-converted by a resistive driver or an operation amplifier															
10	V4																	



11	V3		for application. Voltages should be according to the following relationship: $V0 \geq V1 \geq V2 \geq V3 \geq V4 \geq VSS2$ When the on-chip operating power circuit is on ,the following voltages are supplied to V1 to V4 by the on-chip power circuit. Voltages selection is performed by the LCD Bias Set command.
12	V2		
13	V1		
14	NC		No connection
15	NC		No connection
16	C2-	O	Capacitor 2-pad for internal DC/DC voltage converter.
17	C2+	O	Capacitor 2+pad for internal DC/DC voltage converter.
18	C1+		Capacitor 1+pad for internal DC/DC voltage converter.
19	C1-		Capacitor 1-pad for internal DC/DC voltage converter.
20	C3+		Capacitor 3+pad for internal DC/DC voltage converter.
21	NC		No connection
22	VOUT	I/O	DC/DC voltage converter output
23	VSS	O	Ground output for pad option.
24	VDD2	Supply	These are the power supply pads for the step-up voltage circuit for the LCD. These pads must be connected to each other.
25	VDD	O	Power supply output for pad option
26	DUTY1	I	Select the maximum LCD driver duty
27	DUTY0		
28	D7	I/O	This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit standard MPU data bus. When the serial interface is selected (P/S= "L"), then D7 serves as the serial data input terminal (SI) and D6 serves as the serial clock input terminal (SCL). When the serial interface is selected , fix D0~D5 pads to VDD or VSS level. When the chip select is inactive, D0 to D7 are set to high impedance.
29	D6		
30	D5		
31	D4		
32	D3		
33	D2		
34	D1		
35	D0		

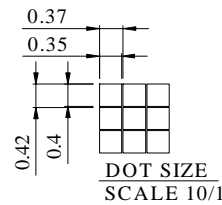
36	/RD	I	When connected to an 8080 MPU ,it is active LOW. This pad is connected to the /RD signal of the 8080 MPU ,and the NT7534 data bus is in an output status when this signal is “L”. When connected to a 6800 Series MPU, this is active HIGH. This is used as an enable clock input of the 6800 series MPU
37	/WR	I	When connected to an 8080 MPU, this is active LOW . This terminal connects to the 8080 MPU, and the NT7534 data bus are latched at rising edge of the /WR signal. When connected to an 8080 MPU, this is the read/write control signal input terminal. When R/W= “H”: Read When R/W= “L”: Write
38	A0	I	This is connected to the least significant bit of the normal MPU address bus, and it determines whether the data bits are data or a command . A0=“H”: Indicate that D0 to D7 are display data A0=“L”: Indicate that D0 to D7 are control data
39	/RES	I	When /RES is set to “L” the settings are initialized. The reset operation is performed by the /RES signal level.
40	CS2	I	This is the chip select signal
41	/CS1		This is the chip select signal
42	NC		No connection
43	/DOF	I/O	This is the liquid crystal display blanking control terminal. M/S=“H”:output M/S= “L”:Inptu When the NT7534chip is used in master/slave mode, the various DOF terminals must be connected.
44	CL		This is the display clock input terminal .When the NT7534 chips are used in master/slave mode ,the various CL terminals must be connected.
45	FR	I/O	This is the liquid crystal alternating current signal I/O terminal M/S=“H”:output M/S= “L”:Inptut When the NT7534chip is used in master/slave mode, the various FR terminals must be connected.
46	NC		No connection
47	NC		No connection
48	NC		No connection
49	NC		No connection

# 8. Contour Drawing & Block Diagram



PIN NO.	SYMBOL	PIN NO.	SYMBOL
26	DUTY1	1	NC
27	DUTY0	2	IRS
28	D7	3	/HPM
29	D6	4	P/S
30	D5	5	C86
31	D4	6	CLS
32	D3	7	M/S
33	D2	8	VR
34	D1	9	V0
35	D0	10	V4
36	/RD	11	V3
37	/WR	12	V2
38	A0	13	V1
39	/RES	14	NC
40	CS2	15	NC
41	/CS1	16	C2-
42	NC	17	C2+
43	/DOF	18	C1+
44	CL	19	C1-
45	FR	20	C3+
46	NC	21	NC
47	NC	22	VOUT
48	NC	23	VSS
49	NC	24	VDD2
		25	VDD

The non-specified tolerance of dimension is  $\pm 0.15$  mm .

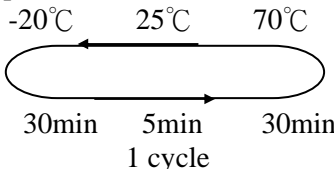


## 9. Fuction Description

Reference to IC NT7534.pdf

# 10. RELIABILITY

## Content of Reliability Test (wide temperature, -20°C~70°C)

Environmental Test			
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	—
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation 	-20°C/70°C 10 cycles	—
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 15mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time	—

**Note1: No dew condensation to be observed.**

**Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.**

**Note3: Vibration test will be conducted to the product itself without putting it in a container.**

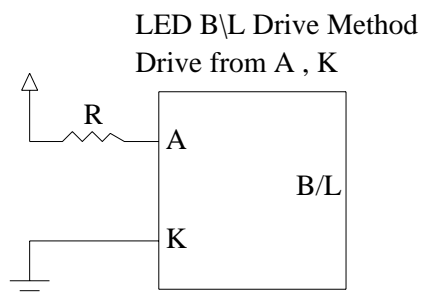
# 11. Backlight Information

## Specification

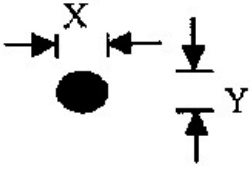
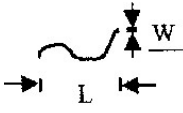
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	I <sub>LED</sub>	48	60	90	mA	V= 3.5V
Supply Voltage	V			5	V	—
Reverse Voltage	V <sub>R</sub>	3.4	3.5	3.6	V	—
Luminous Intensity	I <sub>V</sub>	120	150		CD/M <sup>2</sup>	I <sub>LED</sub> =60mA
Life Time (For Reference only)	—	—	10K	—	Hr.	I <sub>LED</sub> =60mA 25°C,50-60%RH, (Note 1)
Color	White					

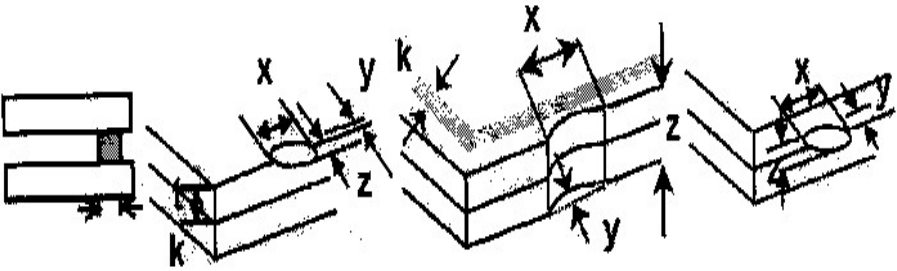
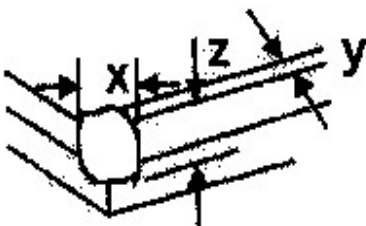
**Note:** The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

**Note 1:**The brightness will decrease to 50% of the original value after 10K hours

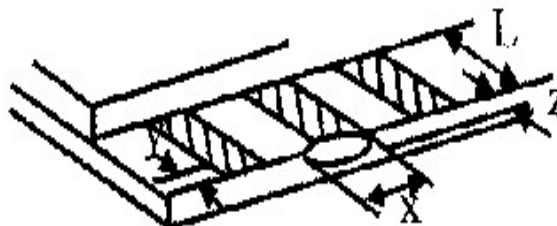
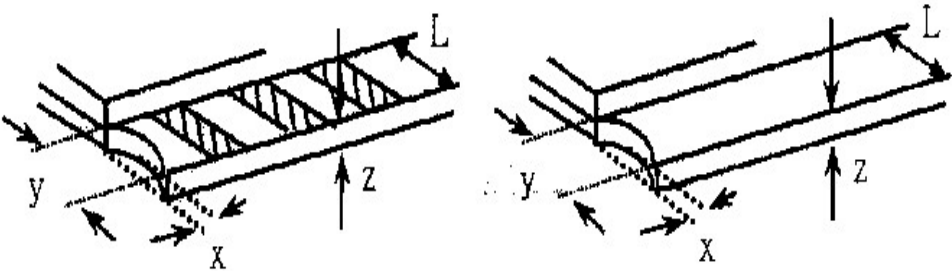
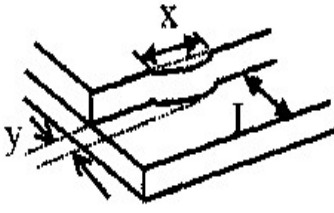


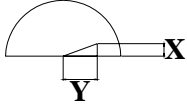
# 12. Inspection specification

NO	Item	Criterion	AQL												
01	Electrical Testing	1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character , dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect.	0.65												
02	Black or white spots on LCD (display only)	2.1 White and black spots on display $\leq 0.25\text{mm}$ , no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm	2.5												
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type : As following drawing $\Phi = (x + y) / 2$  <table border="1" data-bbox="877 824 1364 1041"> <thead> <tr> <th>SIZE</th> <th>Acceptable Q TY</th> </tr> </thead> <tbody> <tr> <td><math>\Phi \leq 0.10</math></td> <td>Accept no dense</td> </tr> <tr> <td><math>0.10 &lt; \Phi \leq 0.20</math></td> <td>2</td> </tr> <tr> <td><math>0.20 &lt; \Phi \leq 0.25</math></td> <td>1</td> </tr> <tr> <td><math>0.25 &lt; \Phi</math></td> <td>0</td> </tr> </tbody> </table>	SIZE	Acceptable Q TY	$\Phi \leq 0.10$	Accept no dense	$0.10 < \Phi \leq 0.20$	2	$0.20 < \Phi \leq 0.25$	1	$0.25 < \Phi$	0	2.5		
		SIZE	Acceptable Q TY												
$\Phi \leq 0.10$	Accept no dense														
$0.10 < \Phi \leq 0.20$	2														
$0.20 < \Phi \leq 0.25$	1														
$0.25 < \Phi$	0														
3.2 Line type : (As following drawing)  <table border="1" data-bbox="710 1102 1364 1317"> <thead> <tr> <th>Length</th> <th>Width</th> <th>Acceptable Q TY</th> </tr> </thead> <tbody> <tr> <td>---</td> <td><math>W \leq 0.02</math></td> <td>Accept no dense</td> </tr> <tr> <td><math>L \leq 3.0</math></td> <td><math>0.02 &lt; W \leq 0.03</math></td> <td rowspan="2">2</td> </tr> <tr> <td><math>L \leq 2.5</math></td> <td><math>0.03 &lt; W \leq 0.05</math></td> </tr> <tr> <td>---</td> <td><math>0.05 &lt; W</math></td> <td>As round type</td> </tr> </tbody> </table>	Length	Width	Acceptable Q TY	---	$W \leq 0.02$	Accept no dense	$L \leq 3.0$	$0.02 < W \leq 0.03$	2	$L \leq 2.5$	$0.03 < W \leq 0.05$	---	$0.05 < W$	As round type	2.5
Length	Width	Acceptable Q TY													
---	$W \leq 0.02$	Accept no dense													
$L \leq 3.0$	$0.02 < W \leq 0.03$	2													
$L \leq 2.5$	$0.03 < W \leq 0.05$														
---	$0.05 < W$	As round type													
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction. <table border="1" data-bbox="762 1361 1364 1617"> <thead> <tr> <th>Size <math>\Phi</math></th> <th>Acceptable Q TY</th> </tr> </thead> <tbody> <tr> <td><math>\Phi \leq 0.20</math></td> <td>Accept no dense</td> </tr> <tr> <td><math>0.20 &lt; \Phi \leq 0.50</math></td> <td>3</td> </tr> <tr> <td><math>0.50 &lt; \Phi \leq 1.00</math></td> <td>2</td> </tr> <tr> <td><math>1.00 &lt; \Phi</math></td> <td>0</td> </tr> <tr> <td>Total Q TY</td> <td>3</td> </tr> </tbody> </table>	Size $\Phi$	Acceptable Q TY	$\Phi \leq 0.20$	Accept no dense	$0.20 < \Phi \leq 0.50$	3	$0.50 < \Phi \leq 1.00$	2	$1.00 < \Phi$	0	Total Q TY	3	2.5
Size $\Phi$	Acceptable Q TY														
$\Phi \leq 0.20$	Accept no dense														
$0.20 < \Phi \leq 0.50$	3														
$0.50 < \Phi \leq 1.00$	2														
$1.00 < \Phi$	0														
Total Q TY	3														

NO	Item	Criterion	AQL																		
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination																			
06	Chipped glass	<p>Symbols Define:  x: Chip length            y: Chip width            z: Chip thickness  k: Seal width            t: Glass thickness       a: LCD side length  L: Electrode pad length:</p> <p>6.1 General glass chip :  6.1.1 Chip on panel surface and crack between panels:</p>  <table border="1" data-bbox="446 963 1364 1131"> <tr> <td>z: Chip thickness</td> <td>y: Chip width</td> <td>x: Chip length</td> </tr> <tr> <td><math>Z \leq 1/2t</math></td> <td>Not over viewing area</td> <td><math>x \leq 1/8a</math></td> </tr> <tr> <td><math>1/2t &lt; z \leq 2t</math></td> <td>Not exceed 1/3k</td> <td><math>x \leq 1/8a</math></td> </tr> </table> <p>⊙If there are 2 or more chips, x is total length of each chip.</p> <p>6.1.2 Corner crack:</p>  <table border="1" data-bbox="446 1523 1364 1691"> <tr> <td>z: Chip thickness</td> <td>y: Chip width</td> <td>x: Chip length</td> </tr> <tr> <td><math>Z \leq 1/2t</math></td> <td>Not over viewing area</td> <td><math>x \leq 1/8a</math></td> </tr> <tr> <td><math>1/2t &lt; z \leq 2t</math></td> <td>Not exceed 1/3k</td> <td><math>x \leq 1/8a</math></td> </tr> </table> <p>⊙If there are 2 or more chips, x is the total length of each chip.</p>	z: Chip thickness	y: Chip width	x: Chip length	$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$	$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$	z: Chip thickness	y: Chip width	x: Chip length	$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$	$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$	2.5
z: Chip thickness	y: Chip width	x: Chip length																			
$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$																			
$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$																			
z: Chip thickness	y: Chip width	x: Chip length																			
$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$																			
$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$																			



NO	Item	Criterion	AQL																
06	Glass crack	<p>Symbols :</p> <p>x: Chip length      y: Chip width      z: Chip thickness  k: Seal width      t: Glass thickness      a: LCD side length  L: Electrode pad length</p> <p>6.2 Protrusion over terminal :</p> <p>6.2.1 Chip on electrode pad :</p>  <table border="1" data-bbox="359 795 1268 884"> <tr> <td>y: Chip width</td> <td>x: Chip length</td> <td>z: Chip thickness</td> </tr> <tr> <td><math>y \leq 0.5\text{mm}</math></td> <td><math>x \leq 1/8a</math></td> <td><math>0 &lt; z \leq t</math></td> </tr> </table> <p>6.2.2 Non-conductive portion:</p>  <table border="1" data-bbox="430 1209 1268 1299"> <tr> <td>y: Chip width</td> <td>x: Chip length</td> <td>z: Chip thickness</td> </tr> <tr> <td><math>y \leq L</math></td> <td><math>x \leq 1/8a</math></td> <td><math>0 &lt; z \leq t</math></td> </tr> </table> <p>⊙If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.  ⊙If the product will be heat sealed by the customer, the alignment mark not be damaged.</p> <p>6.2.3 Substrate protuberance and internal crack.</p>  <table border="1" data-bbox="766 1523 1268 1612"> <tr> <td>y: width</td> <td>x: length</td> </tr> <tr> <td><math>y \leq 1/3L</math></td> <td><math>x \leq a</math></td> </tr> </table>	y: Chip width	x: Chip length	z: Chip thickness	$y \leq 0.5\text{mm}$	$x \leq 1/8a$	$0 < z \leq t$	y: Chip width	x: Chip length	z: Chip thickness	$y \leq L$	$x \leq 1/8a$	$0 < z \leq t$	y: width	x: length	$y \leq 1/3L$	$x \leq a$	2.5
y: Chip width	x: Chip length	z: Chip thickness																	
$y \leq 0.5\text{mm}$	$x \leq 1/8a$	$0 < z \leq t$																	
y: Chip width	x: Chip length	z: Chip thickness																	
$y \leq L$	$x \leq 1/8a$	$0 < z \leq t$																	
y: width	x: length																		
$y \leq 1/3L$	$x \leq a$																		

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong.	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB · COB	10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB  $X * Y \leq 2\text{mm}^2$	2.5 2.5 0.65 2.5 2.5 0.65 0.65 2.5 2.5 2.5
11	Soldering	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
12	General appearance	12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.	2.5
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever.	2.5
		12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.	2.5
		12.7 Sealant on top of the ITO circuit has not hardened.	0.65
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging specification sheet.	0.65
		12.11 Product dimension and structure must conform to product specification sheet.	

# 13. Material List of Components for RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark “#”in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A : The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm

Above limited value is set up according to RoHS.

2.Process for RoHS requirement :

- (1) Use the Sn/Ag/Cu soldering surface ; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :  
Reflow : 250°C,30 seconds Max. ;  
Connector soldering wave or hand soldering : 320°C, 10 seconds max.
- (3) Temp. curve of reflow, max. Temp. : 235±5°C ;  
Recommended customer’s soldering temp. of connector : 280°C, 3 seconds.



winstar **LCM Sample Estimate Feedback Sheet**

Module Number : \_\_\_\_\_

Page: 1

**1、Panel Specification :**

- 1. Panel Type :  Pass  NG , \_\_\_\_\_
- 2. View Direction :  Pass  NG , \_\_\_\_\_
- 3. Numbers of Dots :  Pass  NG , \_\_\_\_\_
- 4. View Area :  Pass  NG , \_\_\_\_\_
- 5. Active Area :  Pass  NG , \_\_\_\_\_
- 6. Operating Temperature :  Pass  NG , \_\_\_\_\_
- 7. Storage Temperature :  Pass  NG , \_\_\_\_\_
- 8. Others : \_\_\_\_\_

**2、Mechanical Specification :**

- 1. PCB Size :  Pass  NG , \_\_\_\_\_
- 2. Frame Size :  Pass  NG , \_\_\_\_\_
- 3. Material of Frame :  Pass  NG , \_\_\_\_\_
- 4. Connector Position :  Pass  NG , \_\_\_\_\_
- 5. Fix Hole Position :  Pass  NG , \_\_\_\_\_
- 6. Backlight Position :  Pass  NG , \_\_\_\_\_
- 7. Thickness of PCB :  Pass  NG , \_\_\_\_\_
- 8. Height of Frame to PCB :  Pass  NG , \_\_\_\_\_
- 9. Height of Module :  Pass  NG , \_\_\_\_\_
- 10. Others :  Pass  NG , \_\_\_\_\_

**3、Relative Hole Size :**

- 1. Pitch of Connector :  Pass  NG , \_\_\_\_\_
- 2. Hole size of Connector :  Pass  NG , \_\_\_\_\_
- 3. Mounting Hole size :  Pass  NG , \_\_\_\_\_
- 4. Mounting Hole Type :  Pass  NG , \_\_\_\_\_
- 5. Others :  Pass  NG , \_\_\_\_\_

**4、Backlight Specification :**

- 1. B/L Type :  Pass  NG , \_\_\_\_\_
- 2. B/L Color :  Pass  NG , \_\_\_\_\_
- 3. B/L Driving Voltage (Reference for LED Type) :  Pass  NG , \_\_\_\_\_
- 4. B/L Driving Current :  Pass  NG , \_\_\_\_\_
- 5. Brightness of B/L :  Pass  NG , \_\_\_\_\_
- 6. B/L Solder Method :  Pass  NG , \_\_\_\_\_
- 7. Others :  Pass  NG , \_\_\_\_\_

>> **Go to page 2** <<

Module Number : \_\_\_\_\_

Page: 2

**5、Electronic Characteristics of Module :**

- |                              |                               |                                     |
|------------------------------|-------------------------------|-------------------------------------|
| 1. Input Voltage :           | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 2. Supply Current :          | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 3. Driving Voltage for LCD : | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 4. Contrast for LCD :        | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 5. B/L Driving Method :      | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 6. Negative Voltage Output : | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 7. Interface Function :      | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 8. LCD Uniformity :          | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 9. ESD test :                | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 10. Others :                 | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |

**6、Summary :**

Sales signature : \_\_\_\_\_

Customer Signature : \_\_\_\_\_

Date :     /     /     \_\_\_\_\_